



November 1997

FDC653N N-Channel Enhancement Mode Field Effect Transistor

General Description

This N-Channel enhancement mode power field effect transistors is produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is tailored to minimize on-state resistance. These devices are particularly suited for low voltage applications in notebook computers, portable phones, PCMCIA cards, and other battery powered circuits where fast switching, and low in-line power loss are needed in a very small outline surface mount package.

Features

- 5 A, 30 V. $R_{DS(ON)} = 0.035 \Omega$ @ $V_{GS} = 10$ V
 $R_{DS(ON)} = 0.055 \Omega$ @ $V_{GS} = 4.5$ V.
- Proprietary SuperSOT™-6 package design using copper lead frame for superior thermal and electrical capabilities.
- High density cell design for extremely low $R_{DS(ON)}$.
- Exceptional on-resistance and maximum DC current capability.



SOT-23



SuperSOT™-6



SuperSOT™-8



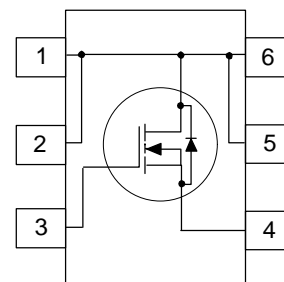
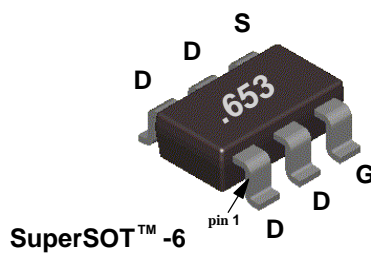
SO-8



SOT-223



SOIC-16



Absolute Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise note

Symbol	Parameter	FDC653N	Units
V_{DSS}	Drain-Source Voltage	30	V
V_{GSS}	Gate-Source Voltage - Continuous	± 20	V
I_D	Drain Current - Continuous (Note 1a)	5	A
	- Pulsed	15	
P_D	Maximum Power Dissipation (Note 1a)	1.6	W
	(Note 1b)	0.8	
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to 150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	78	$^\circ\text{C/W}$
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Note 1)	30	$^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	30			V
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	$I_D = 250\text{ }\mu\text{A}$, Referenced to 25°C		31		$\text{mV}/^{\circ}\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24\text{ V}, V_{GS} = 0\text{ V}$			1	μA
		$T_J = 55^{\circ}\text{C}$			10	μA
I_{GSSF}	Gate - Body Leakage, Forward	$V_{GS} = 20\text{ V}, V_{DS} = 0\text{ V}$			100	nA
I_{GSSR}	Gate - Body Leakage, Reverse	$V_{GS} = -20\text{ V}, V_{DS} = 0\text{ V}$			-100	nA
ON CHARACTERISTICS (Note 2)						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	1	1.7	2	V
$\Delta V_{GS(th)}/\Delta T_J$	Gate Threshold Voltage Temp. Coefficient	$I_D = 250\text{ }\mu\text{A}$, Referenced to 25°C		-4.2		$\text{mV}/^{\circ}\text{C}$
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{ V}, I_D = 5\text{ A}$		0.027	0.035	Ω
		$T_J = 125^{\circ}\text{C}$		0.042	0.056	
		$V_{GS} = 4.5\text{ V}, I_D = 4.2\text{ A}$		0.046	0.055	
$I_{D(on)}$	On-State Drain Current	$V_{GS} = 10\text{ V}, V_{DS} = 5\text{ V}$	8			A
g_{FS}	Forward Transconductance	$V_{DS} = 10\text{ V}, I_D = 5\text{ A}$		6.2		S
DYNAMIC CHARACTERISTICS						
C_{iss}	Input Capacitance	$V_{DS} = 15\text{ V}, V_{GS} = 0\text{ V},$		350		pF
C_{oss}	Output Capacitance	$f = 1.0\text{ MHz}$		220		pF
C_{rss}	Reverse Transfer Capacitance			80		pF
SWITCHING CHARACTERISTICS (Note 2)						
$t_{D(on)}$	Turn - On Delay Time	$V_{DD} = 10\text{ V}, I_D = 1\text{ A},$		7.5	15	ns
t_r	Turn - On Rise Time	$V_{GS} = 4.5\text{ V}, R_{GEN} = 6\text{ }\Omega$		12	25	ns
$t_{D(off)}$	Turn - Off Delay Time			13	25	ns
t_f	Turn - Off Fall Time			6	15	ns
Q_g	Total Gate Charge	$V_{DS} = 15\text{ V}, I_D = 5\text{ A},$		12	17	nC
Q_{gs}	Gate-Source Charge	$V_{GS} = 10\text{ V}$		2.1		nC
Q_{gd}	Gate-Drain Charge			2.6		nC
DRAIN-SOURCE DIODE CHARACTERISTICS						
I_S	Continuous Source Diode Current				1.3	A
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_S = 1.3\text{ A}$ (Note 2)		0.75	1.2	V
		$T_J = 125^{\circ}\text{C}$		0.6	1	

Notes:

- $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.
 - $78^{\circ}\text{C}/\text{W}$ when mounted on a minimum on a 1 in^2 pad of 2oz Cu in FR-4 board.
 - $156^{\circ}\text{C}/\text{W}$ when mounted on a minimum pad of 2oz Cu in FR-4 board.
- Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2.0\%$.

Typical Electrical Characteristics

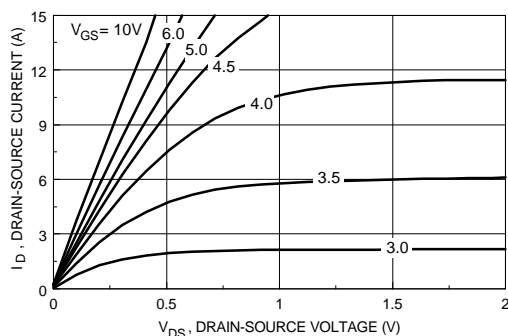


Figure 1. On-Region Characteristics.

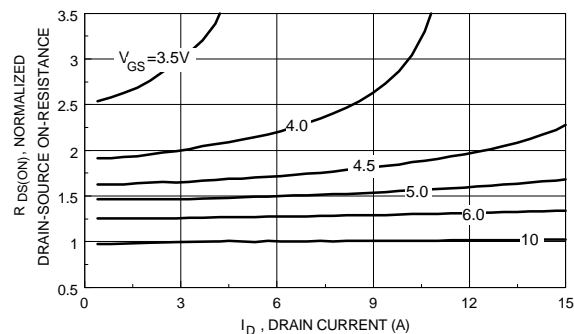


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

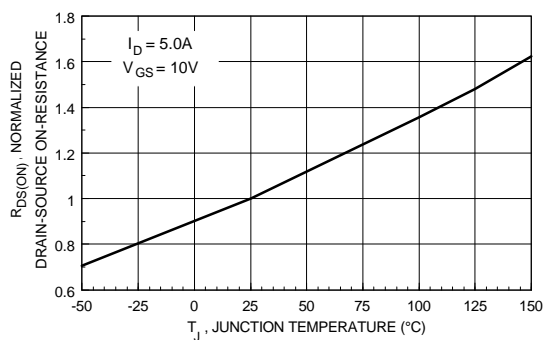


Figure 3. On-Resistance Variation with Temperature.

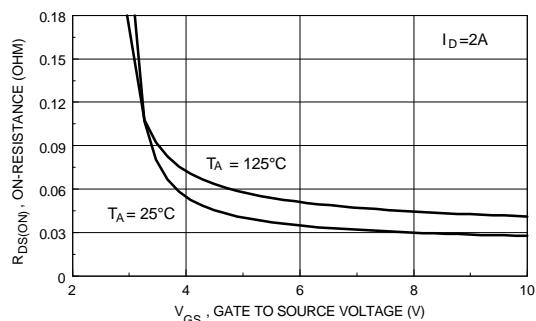


Figure 4. On Resistance Variation with Gate-To- Source Voltage.

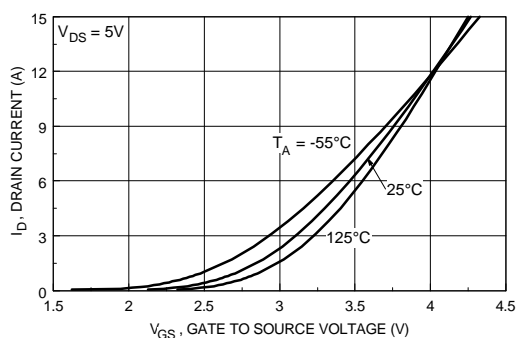


Figure 5. Transfer Characteristics.

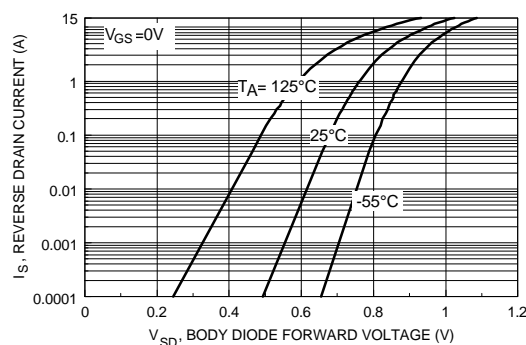


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Electrical And Thermal Characteristics

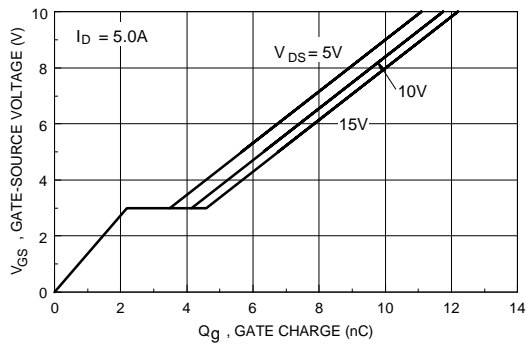


Figure 7. Gate Charge Characteristics.

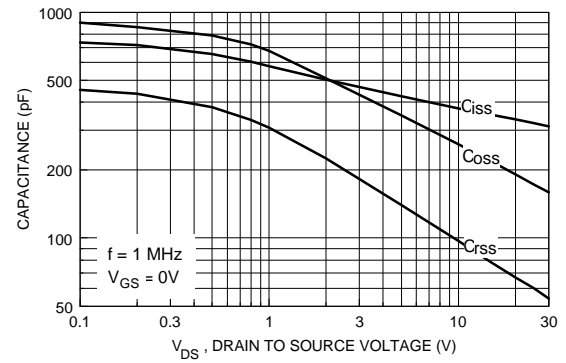


Figure 8. Capacitance Characteristics.

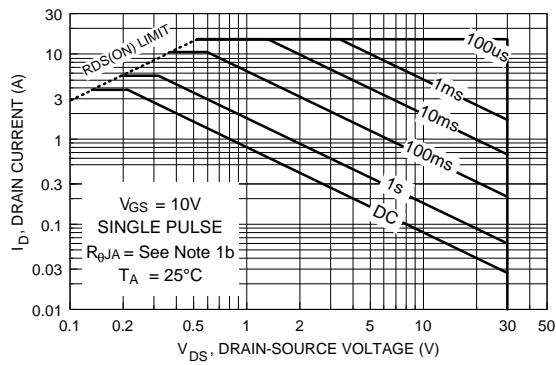


Figure 9. Maximum Safe Operating Area.

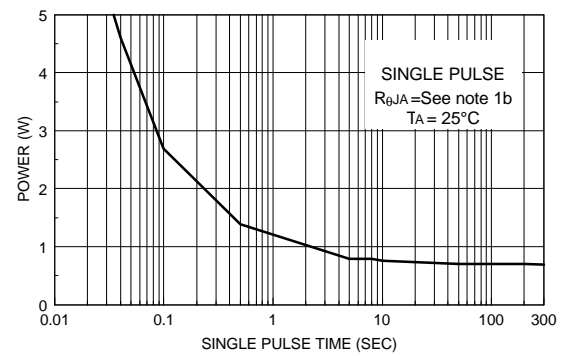


Figure 10. Single Pulse Maximum Power Dissipation.

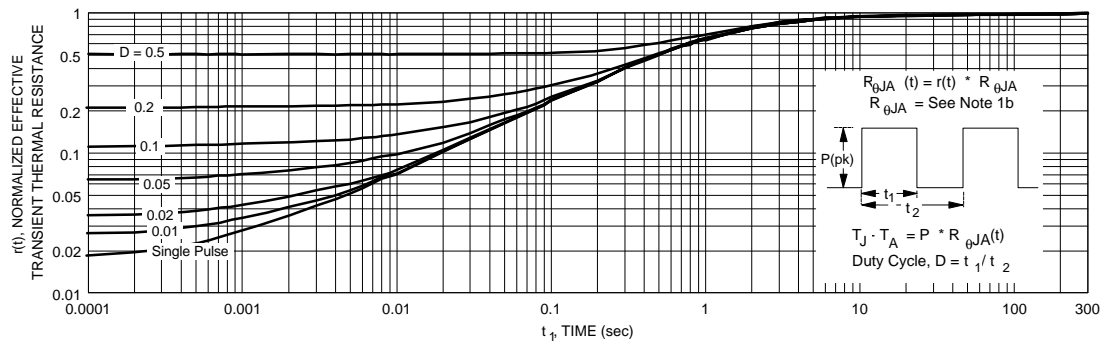


Figure 11. Transient Thermal Response Curve.

Note: Thermal characterization performed using the conditions described in note 1b. Transient thermal response will change depending on the circuit board design.

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACE ^x TM	FAST [®]	OPTOLOGIC TM	SMART START TM	VCX TM
Bottomless TM	FAST ^r TM	OPTOPLANAR TM	STAR*POWER TM	
CoolFET TM	FRFET TM	PACMAN TM	Stealth TM	
CROSSVOLT TM	GlobalOptoisolator TM	POP TM	SuperSOT TM -3	
DenseTrench TM	GTO TM	Power247 TM	SuperSOT TM -6	
DO TM	HiSeC TM	PowerTrench [®]	SuperSOT TM -8	
EcoSPARK TM	ISOPLANAR TM	QFET TM	SyncFET TM	
E ² CMOS TM	LittleFET TM	QS TM	TinyLogic TM	
EnSigna TM	MicroFET TM	QT Optoelectronics TM	TruTranslation TM	
FACT TM	MicroPak TM	Quiet Series TM	UHC TM	
FACT Quiet Series TM	MICROWIRE TM	SILENT SWITCHER [®]	UltraFET [®]	

STAR*POWER is used under license

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.



Home >> Find products >>

FDC653N

N-Channel Enhancement Mode Field Effect Transistor

Contents

- [General description](#)
- [Features](#)
- [Product status/pricing/packageing](#)
- [Order Samples](#)
- [Models](#)
- [Qualification Support](#)

General description

This N-Channel enhancement mode power field effect transistors is produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is tailored to minimize on-state resistance. These devices are particularly suited for low voltage applications in notebook computers, portable phones, PCMCIA cards, and other battery powered circuits where fast switching, and low in-line power loss are needed in a very small outline surface mount package.

[back to top](#)

Features

- 5 A, 30 V. $R_{DS(ON)} = 0.035 \Omega @ V_{GS} = 10 \text{ V}$, $R_{DS(ON)} = 0.055 \Omega @ V_{GS} = 4.5 \text{ V}$.
- Proprietary SuperSOT™-6 package design using copper lead frame for superior thermal and electrical capabilities.
- High density cell design for extremely low $R_{DS(ON)}$.
- Exceptional on-resistance and maximum DC current capability.

[back to top](#)

Product status/pricing/packageing

BUY

Product	Product status	Pb-free Status	Pricing*	Package type	Leads	Packing method	Package I

BUY

Datasheet

[Download this datasheet](#)



[e-mail this datasheet](#)



This page

[Print version](#)

This product

[Use in FETBench Analysis](#)



Related Links

[Request samples](#)

[How to order product](#)

[Product Change Notice \(PCNs\)](#)




[Support](#)

[Sales support](#)

[Quality and reliability](#)

[Design center](#)

mhtml:file:///C:/TEMP/FDC653N_NB3E005A.mht

FDC653N	Full Production	 Full Production	\$0.372	SSOT-6	6	TAPE REEL	Line 1: &E&Y (Bi Line 2: .653
FDC653N_NB3E005A	Full Production	 Full Production	N/A	SSOT-6	6	TAPE REEL	Line 1: &E&Y (Bi Line 2: .653
FDC653N_NF073	Full Production	 Full Production	N/A	SSOT-6	6	TAPE REEL	Line 1: &E&Y (Bi Line 2: .653

* Fairchild 1,000 piece Budgetary Pricing

** A sample button will appear if the part is available through Fairchild's on-line samples program. If there is no sample button, please contact a [Fairchild distributor](#) to obtain samples



Indicates product with Pb-free second-level interconnect. For more information [click here](#).

Package marking information for product FDC653N is available. [Click here for more information](#).

[back to top](#)

Models

Package & leads	Condition	Temperature range	Software version
PSPICE			
SSOT-6-6	Electrical	25°C to 125°C	Orcad 9.1

[back to top](#)

Qualification Support

Click on a product for detailed qualification data

Product
FDC653N
FDC653N_NB3E005A
FDC653N_NF073

[back to top](#)

mhtml:file:///C:/TEMP/FDC653N_NB3E005A.mht

© 2007 Fairchild Semiconductor

[Products](#) | [Design Center](#) | [Support](#) | [Company News](#) | [Investors](#) | [My Fairchild](#) | [Contact Us](#) | [Site Index](#) | [Privacy Policy](#) | [Site Terms & Conditions](#)

mhtml:file:///C:/TEMP/FDC653N_NB3E005A.mht